LM5022 54Vin to 12Vout @ 3A Flyback

Variant/Label Table

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<th>Variant</th>
<th>Label Text</th>
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<td>001</td>
<td>LOGO</td>
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<td>PCB</td>
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<td>FCC disclaimer</td>
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PCB: PMP20551 RevA

!PCB?
PMP20551 RevA

**Assembly Note ZZ1**

This Assembly Note is for PCB labels only

**Assembly Note ZZ2**

These assemblies are ESD sensitive. ESD precautions shall be observed.

**Assembly Note ZZ3**

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

**Assembly Note ZZ4**

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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